

#### 1.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER PowerDI123

### **Product Summary**

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F</sub> Max (V)	I <sub>R</sub> Max (μA)	
60	1	0.50	100	

#### **Features and Benefits**

- Guard Ring Die Construction for Transient Protection
- High Current Capability
- Low Leakage Current
- Patented Interlocking Clip Design for High Surge Current Capacity
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Applications**

- Bridge Diodes
- **Blocking Diodes**
- **Reverse Protection Diodes**

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 🐹
- Weight: 0.018 grams (Approximate)

#### PowerDI123



Top View

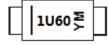
# Ordering Information (Note 4)

Part Number	Case	Packaging
SDM1U60P1-7	PowerDI123	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



1U60 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017)M = Month (ex: 5 = May)

Date Code Key

Year	2014	2015	20	16	2017	2018	2019	2020	) 20	)21	2022	2023
Code	В	С	[	)	Е	F	G	Н		I	J	K
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	Ο	N	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Forward Current	I <sub>F(AV)</sub>	1.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	60	А

### **Thermal Characteristics**

Characteristic	Symbol	Тур	Unit
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	60	°C/W
Thermal Resistance, Junction to Case (Note 5)	Rejc	5	°C/W
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage	V <sub>F</sub>	_	0.45	0.50	W	I <sub>F</sub> = 1.0A, T <sub>A</sub> = +25°C
Forward voilage		_	0.40	_	V	$I_F = 1.0A, T_A = +125$ °C
Lookaga Current (Nota 6)		_	15	100	μΑ	$V_R = 60V, T_A = +25$ °C
Leakage Current (Note 6)	IR	_	10	_	mA	$V_R = 60V, T_A = +125^{\circ}C$
Total Capacitance	Ст	_	52	_	pF	$V_R = 10V, f = 1.0MHz$

Notes:

- 5. Device mounted on 1 inch sq. copper pad, 2oz.6. Short duration pulse test used to minimize self-heating effect.



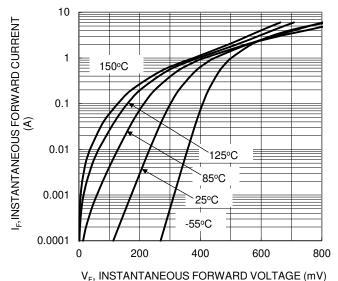


Figure 1. Typical Forward Characteristics

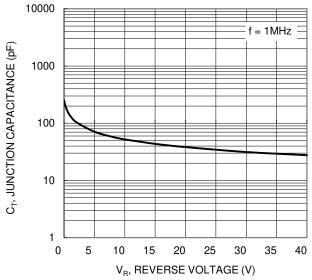


Figure 3. Typical Junction Capacitance

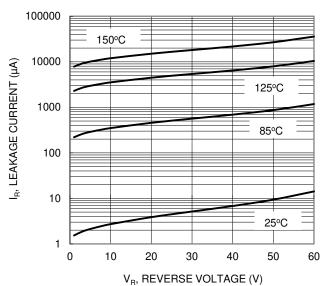
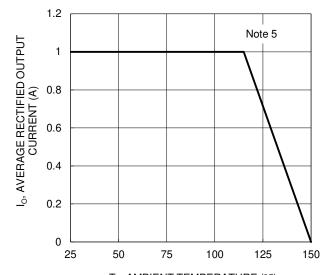


Figure 2. Typical Reverse Characteristics



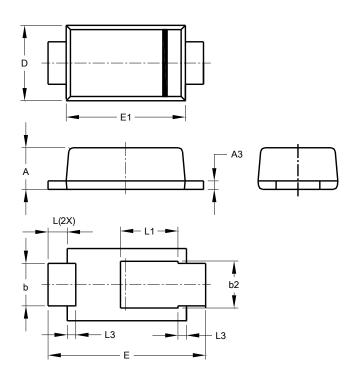
T<sub>A</sub>, AMBIENT TEMPERATURE (°C) Figure 4. DC Forward Current Derating



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123

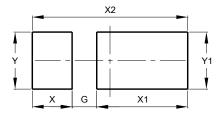


PowerDI123						
Dim	Min	Max	Тур			
Α	0.93	1.00	0.98			
А3	0.15	0.25	0.20			
b	0.85	1.25	1.00			
b2	1.025	1.125	1.10			
D	1.63	1.93	1.78			
Е	3.50	3.90	3.70			
E1	2.60	3.00	2.80			
L	0.40	0.50	0.45			
L1	1.25	1.40	1.35			
L3	0.125	0.275	0.20			
All Dimensions in mm						

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI123



Dimensions	Value (in mm)			
G	0.65			
Х	1.05			
X1	2.40			
X2	4.10			
Υ	1.50			
V1	1.50			



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